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URL for Additional Information

PART INFORMATION

Mfg Item Number

Mfg Item Name

SMALL OUTLINE SMT

Company Name Freescale Semiconductor Inc Company Unique ID 14-141-7928 Response Date 2013-01-08 Response Document ID 0870K50010S291A1.18 Contact Name Freescale Semiconductor Inc Contact Title Product Technical Support **Contact Phone** 1-800-521-6274 Contact Email support@freescale.com **Authorized Representative** Daniel Binyon Representative Title **EPP Customer Response** Representative Phone 512-895-3406 Representative Email eppanlst@freescale.com

DECLARATION

EU RoHS
Pb Free
Yes
HalogenFree
Plating Indicator
EU RoHS Exemption(s)

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MANUFACTURING Mfg Item Number MPVZ4006G6T1 Mfg Item Name SMALL OUTLINE SMT Version ALL Weight 1.042500 UoM Unit Volume EACH J-STD-020 MSL Rating Peak Processing Temperature Max Time at Peak Temperature Number of Processing Cycles

2011/65/EU **RoHS Directive** RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material of Cadmium **RoHS Definition** Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part(s) identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a RoHS restricted substance) in excess of the applicable quantity limit identified below. If a homogeneous material within the part(s) contains a RoHS restricted substance in excess **RoHS Legal Definition** restricted substance) in excess of the applicable quantity limit identified below. If a homogeneous material within the part(s) contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Suppliers liability and the Companys remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Suppliers Standard Terms and Conditions of Sale applicable to such part(s) shall apply. Sale applicable to such part(s) shall apply. **RoHS Declaration** 1 - Item(s) do not contain RoHS restricted substances per the definition above Accepted Supplier Acceptance Signature **Daniel Binyon** Exemptions in this part List of Freescale Accepted Exemptions 6(a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight 6(b): Lead as an alloying element in aluminium containing up to 0.4% lead by weight 6(c): Copper alloy containing up to 4% lead by weight 7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead) 7(b) : Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission, and network management for 7(c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound 7(c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher 7(c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC 7(c)-IV: Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors

15 : Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages

SubPart	Weight	SubstanceClass	Substance	CAS Exe	emption	SubstanceWeight	UoM	SubPart PPM	SubPart%	REACHPPM	REACH%
Cap/Cover	0.1958						g				
Cap/Cover		Metals	Chromium, metal	7440-47-3		0.035286	g	180216	18.0216	33847	3.3847
Cap/Cover		Solvents, additives, and other materials	Sulfur	7704-34-9		0.000059	g	300	0.03	56	0.0056
Cap/Cover		Solvents, additives, and other materials	Phosphorus	7723-14-0		0.000078	g	400	0.04	74	0.0074
Cap/Cover		Solvents, additives, and other materials	Silicon	7440-21-3		0.00147	g	7509	0.7509	1410	0.141
Cap/Cover		Metals	Iron, metal	7439-89-6		0.156947	g	801563	80.1563	150550	15.055
Cap/Cover		Metals	Manganese, metal	7439-96-5		0.00196	g	10012	1.0012	1880	0.188
Non-Conductive Epoxy/Adhesive	0.0027						g				
Non-Conductive Epoxy/Adhesive		Solvents, additives, and other materials	Silicone gum	67762-94-1		0.000028	g	10324	1.0324	26	0.0026
Non-Conductive Epoxy/Adhesive		Solvents, additives, and other materials	Siloxanes and Silicones, di-Me, Me vinyl, vinyl group-terminated	68083-18-1		0.000332	g	122911	12.2911	318	0.0318
Non-Conductive Epoxy/Adhesive		Solvents, additives, and other materials	Siloxanes and silicones, di-Me, vinyl group-terminated	68083-19-2		0.001062	g	393313	39.3313	1018	0.1018
Non-Conductive Epoxy/Adhesive		Solvents, additives, and other materials	Proprietary Material-Other siloxanes and silicones	-		0.000597	g	221239	22.1239	572	0.0572
Non-Conductive Epoxy/Adhesive		Glass	D4 and HMDZ treated Silicon Dioxide	68937-51-9		0.000398	g	147493	14.7493	381	0.0381
Non-Conductive Epoxy/Adhesive		Glass	Silica, crystalline - quartz (SiO2)	14808-60-7		0.000252	g	93412	9.3412	241	0.0241
Non-Conductive Epoxy/Adhesive		Metals	Titanium (IV) Oxide	13463-67-7		0.000031	g	11308	1.1308	29	0.0029
Bonding Wire	0.0011						g				
Bonding Wire		Metals	Gold, metal	7440-57-5		0.0011	g	1000000	100	1055	0.1055
Copper Lead Frame	0.7789						g				
Copper Lead Frame		Metals	Copper, metal	7440-50-8		0.431318	g	553753	55.3753	413744	41.3744
Copper Lead Frame		Plastics/polymers	Proprietary Material-Other Epoxy resins	-		0.016413	g	21072	2.1072	15743	1.5743
Copper Lead Frame		Metals	Gold, metal	7440-57-5		0.000613	g	787	0.0787	588	0.0588
Copper Lead Frame		Solvents, additives, and other materials	Phosphorus	7723-14-0		0.000361	g	463	0.0463	346	0.0346
Copper Lead Frame		Metals	Iron, metal	7439-89-6		0.010306	g	13232	1.3232	9885	0.9885
Copper Lead Frame		Metals	Nickel, metal	7440-02-0		0.006452	g	8283	0.8283	6188	0.6188
Copper Lead Frame		Metals	Palladium, metal	7440-05-3		0.000316	g	406	0.0406	303	0.0303
Copper Lead Frame		Plastics/polymers	Polyphenylene Sulfide (PPS)	26125-40-6		0.098708	g	126727	12.6727	94684	9.4684
Copper Lead Frame		Glass	Fibrous-glass-wool	65997-17-3		0.213866	g	274575	27.4575	205150	20.515
Copper Lead Frame		Metals	Zinc, metal	7440-66-6		0.000547	g	702	0.0702	524	0.0524
Silicon Semiconductor Die	0.0086						g				
Silicon Semiconductor Die		Solvents, additives, and other materials	Other miscellaneous substances (less than 5%).	-		0.000172	g	20000	2	164	0.0164
Silicon Semiconductor Die		Glass	Silicon, doped	- <u>- </u>		0.008428	g	980000	98	8084	0.8084
Gel Die Encapsulant	0.0277						g				
Gel Die Encapsulant		Solvents, additives, and other materials	Fluorosilicone monomer (fluorosilicone rubber)	2374-14-3		0.021606	g	780000	78	20725	2.0725
Gel Die Encapsulant		Plastics/polymers	Oxetane, 2,2,3,3-tetrafluoro-homopolymer, fluorinated	113114-19-5		0.006094	g	220000	22	5845	0.5845
Gel Die Encapsulant	0.0277						g				
Gel Die Encapsulant		Solvents, additives, and other materials	Fluorosilicone monomer (fluorosilicone rubber)	2374-14-3		0.021606	g	780000	78	20725	2.0725
Gel Die Encapsulant		Plastics/polymers	Oxetane, 2,2,3,3-tetrafluoro-homopolymer, fluorinated	113114-19-5		0.006094	g	220000	22	5845	0.5845

LINKS

MCD LINK

http://www.freescale.com Freescale website

GENERAL ENVIRONMENTAL COMPLIANCE LINKS

http://www.freescale.com/files/abstract/corporate/ehs_epp/ENV_ROHS_Freescale_Response.pdf

RoHS signed letter China RoHS http://www.freescale.com/chinarohs

REACH signed letter http://www.freescale.com/files/abstract/corporate/ehs_epp/ENV_REACH_Freescale_Response.pdf http://www.freescale.com/files/abstract/corporate/ehs_epp/ENV_ELV_Freescale_Reponse.pdf ELV signed letter

http://www.freescale.com/files/abstract/corporate/ehs_epp/ENV_CONFLICT_METAL_Freescale_Response.pdf Conflict Minerals statement FREESCALE ENVIRONMENTAL INFORMATION

EPP website

http://www.freescale.com/epp

FAQ

Technical Service Request

LINKS TO BLANK IPC1752 FORMS

http://www.freescale.com/webapp/sps/site/overview.jsp?code=ENVIRON_FAQ

https://www.freescale.com/webapp/servicerequest.create_SR.framework?defaultCategory=Hardware Product Support&defaultTopic=Environmentally Preferred Prod

Blank IPC1752 v0.9 Form $http://www.freescale.com/files/abstract/corporate/ehs_epp/IPC-1752-2_v0.9_MCD_Template.pdf$ http://www.freescale.com/files/abstract/corporate/ehs_epp/IPC-1752-2_v1.1_MCD_Template.pdf Blank IPC1752 v1.1 Form

IPC1752 XML LINKS

http://www.freescale.com/mcds/MPVZ4006G6T1_IPC1752_v09.xml

http://www.freescale.com/mcds/MPVZ4006G6T1_IPC1752_v11.xml

http://www.freescale.com/mcds/MPVZ4006G6T1_IPC1752A.xml